

## RX Family

R01AN5824EJ0100

Rev.1.00

Apr.16.21

## Firmware Update Module Using Firmware Integration Technology

### Introduction

This application note describes the firmware update module using Firmware Integration Technology (FIT). The module is referred to below as the firmware update FIT module.

This application note is based on Renesas MCU Firmware Update Design Policy (R01AN5548). It is recommended that the reader read that document before consulting this application note.

By using the FIT module, users can easily incorporate firmware update functionality into their applications. This application note explains how to use the firmware update FIT module and how to incorporate its API functions into user applications.

### Target Devices

RX231 Group

RX65N Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

### Related Application Notes

Application notes related to this application note are listed below. Refer to them in conjunction with this application note.

- Renesas MCU Firmware Update Design Policy (R01AN5548)
- RX Family How to implement FreeRTOS OTA by using Amazon Web Services on RX65N (R01AN5549)
- Firmware Integration Technology User's Manual (R01AN1833)
- RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)
- RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)
- RX Family Flash Module Using Firmware Integration Technology (R01AN2184)
- RX Family SCI Module Using Firmware Integration Technology (R01AN1815)
- RX Family Ethernet Module Using Firmware Integration Technology (R01AN2009)
- RX Family CMT Module Using Firmware Integration Technology (R01AN1856)
- RX Family BYTEQ Module Using Firmware Integration Technology (R01AN1683)
- RX Family System Timer Module Firmware Integration Technology (R20AN0431)

### Target Compiler

C/C++ Compiler Package for RX Family from Renesas Electronics

For compiler details related to the environment on which operation has been confirmed, refer to 5.1, Confirmed Operation Environment.

## Contents

1. Overview .....	4
1.1 About the Firmware Update Module .....	4
1.2 Configuration of Firmware Update Module .....	4
1.3 API Overview .....	6
2. API Information .....	7
2.1 Hardware Requirements .....	7
2.2 Software Requirements .....	7
2.3 Supported Toolchain .....	7
2.4 Header Files .....	7
2.5 Integer Types .....	7
2.6 Compile Settings .....	8
2.7 Code Size .....	11
2.8 Arguments .....	11
2.9 Return Values .....	13
2.10 Adding the FIT Module to Your Project .....	13
2.11 Note on Status Transition Monitoring Using System Timer .....	14
2.12 “for”, “while” and “do while” Statements .....	14
3. API Functions .....	15
3.1 R_FWUP_Open Function .....	15
3.2 R_FWUP_Close Function .....	15
3.3 R_FWUP_Operation Function .....	16
3.4 R_FWUP_SoftwareReset Function .....	16
3.5 R_FWUP_SetEndOfLife Function .....	17
3.6 R_FWUP_SecureBoot Function .....	17
3.7 R_FWUP_ExecuteFirmware Function .....	18
3.8 R_FWUP_Abort Function .....	18
3.9 R_FWUP_CreateFileForRx Function .....	18
3.10 R_FWUP_CloseFile Function .....	19
3.11 R_FWUP_WriteBlock Function .....	19
3.12 R_FWUP_ActiveNewImage Function .....	19
3.13 R_FWUP_ResetDevice Function .....	20
3.14 R_FWUP_SetPlatformImageState Function .....	20
3.15 R_FWUP_GetPlatformImageState Function .....	20
3.16 R_FWUP_CheckFileSignature Function .....	21
3.17 R_FWUP_ReadAndAssumeCertificate Function .....	21
3.18 R_FWUP_GetVersion Function .....	21
4. Demo Project .....	22
4.1 Firmware Update Using Serial Communications Interface (SCI) of RX65N .....	22

4.1.1	Generating the Firmware Update .....	23
4.1.2	Updating the Firmware .....	26
4.1.3	Generating EOL Firmware .....	27
4.1.4	Firmware EOL .....	27
5.	Appendices .....	28
5.1	Confirmed Operation Environment .....	28
	Revision History .....	29

## 1. Overview

### 1.1 About the Firmware Update Module

The firmware update module can be incorporated into user projects as an API. For instructions on adding the module, refer to 2.10, Adding the FIT Module to Your Project.

### 1.2 Configuration of Firmware Update Module

The firmware update module is middleware for the purpose of updating the firmware of the MCU. Figure 1.1 shows the configuration of a program incorporating the firmware update module, Figure 1.2 shows the configuration of the FreeRTOS OTA demo program, and Table 1.1, lists the FIT modules used.

The firmware to be applied as an update is received via a communication interface and then programmed to the code flash memory of the target device via the firmware update module and flash FIT module.

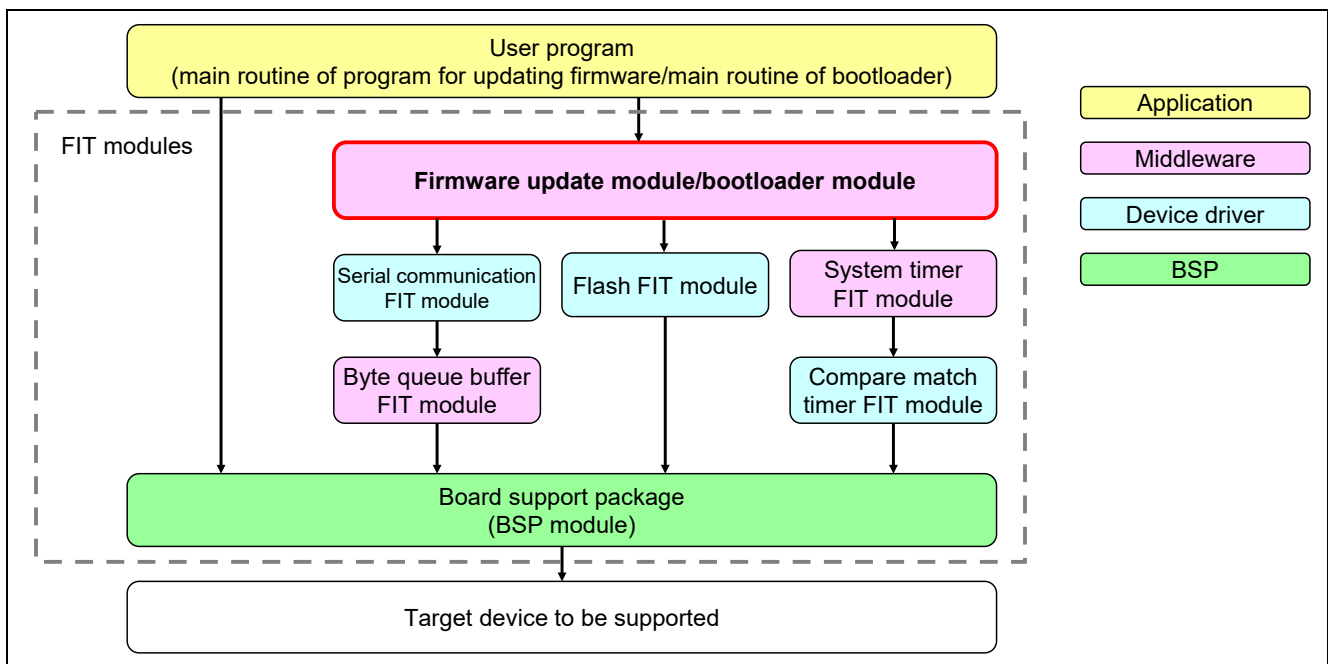


Figure 1.1 Application Configuration Diagram (Firmware Update Environment)

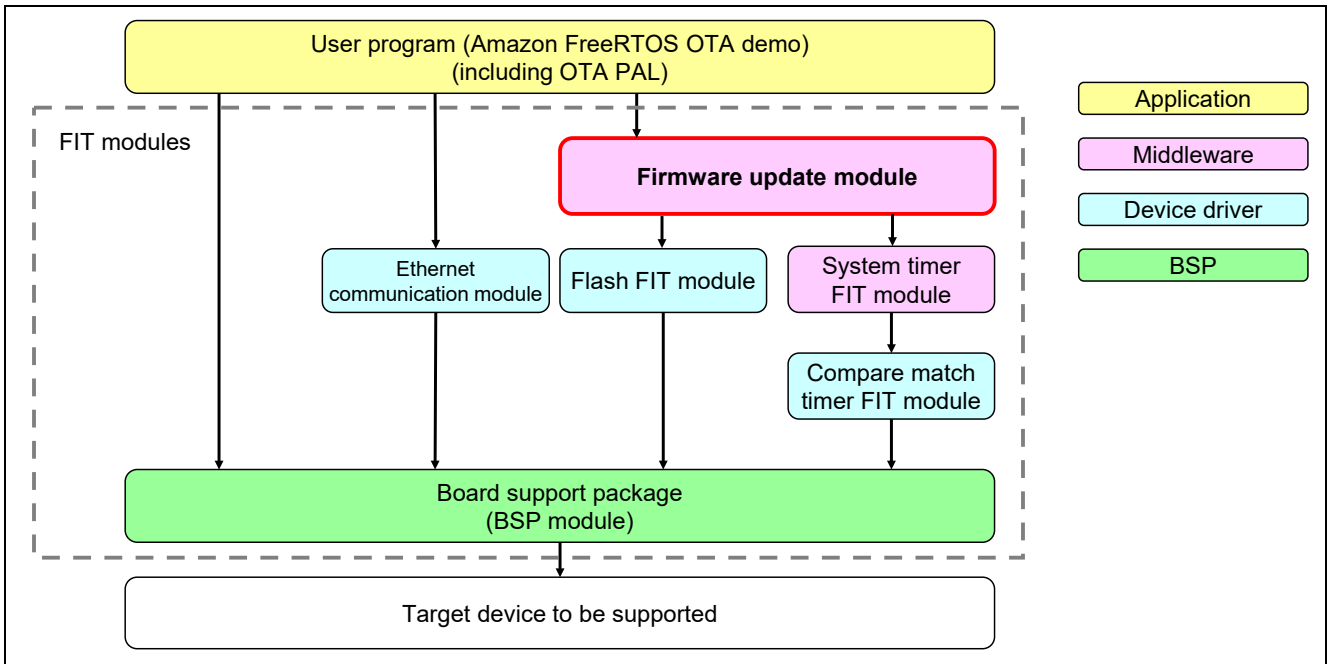


Figure 1.2 Application Configuration Diagram (FreeRTOS OTA Environment)

Table 1.1 List of Modules

Type	Application Note (Document No.)	FIT Module
BSP	RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)	r_bsp
Device driver	RX Family Flash Module Using Firmware Integration Technology (R01AN2184)	r_flash_rx
	RX Family SCI Module Using Firmware Integration Technology (R01AN1815)	r_sci_rx
	RX Family CMT Module Using Firmware Integration Technology (R01AN1856)	r_cmt_rx
	RX Family BYTEQ Module Using Firmware Integration Technology (R01AN1683)	r_byteq
	RX Family System Timer Module Firmware Integration Technology (R20AN0431)	r_sys_time_rx

### 1.3 API Overview

Table 1.2 lists the API functions included in the firmware update module.

**Table 1.2 API Functions**

Function	Function Description	OS Environment		
		FreeRTOS (OTA)	OS-less Environment*1	Bootloader Environment
R_FWUP_Open	Performs processing to open the module.	—	○	—
R_FWUP_Close	Performs processing to close the module.	—	○	—
R_FWUP_Operation	Performs firmware update processing from the user program.	—	○	—
R_FWUP_SoftwareReset	Applies a software reset.	—	○	○
R_FWUP_SetEndOfLife	Performs end of life processing for the user program.	○	○	—
R_FWUP_SecureBoot	Performs secure boot processing using the bootloader.	—	—	○
R_FWUP_ExecuteFirmware	Transfers processing to the installed or updated firmware.	—	—	○
R_FWUP_Abort	Stops OTA update processing.	○	—	—
R_FWUP_CreateFileForRx	Applies initial settings for OTA.	○	—	—
R_FWUP_CloseFile	Closes the specified file.	○	—	—
R_FWUP_WriteBlock	Writes a data block to the specified file at the specified offset.	○	—	—
R_FWUP_ActiveNewImage	Activates or launches the new firmware image.	○	—	—
R_FWUP_SetPlatformImageState	Sets the life cycle status to the status specified by an argument.	○	—	—
R_FWUP_GetPlatformImageState	Returns the current life cycle status.	○	—	—
R_FWUP_CheckFileSignature	Checks the signature of the specified file.	○	—	—
R_FWUP_ReadAndAssumeCertificate	Reads and returns the specified signer certificate from the file system.	○	—	—
R_FWUP_GetVersion	Returns the version number of the module.	○	○	○

Note: 1. An environment in which the firmware update is implemented from the user program, without using an OS such as FreeRTOS.

## 2. API Information

The FIT module has been confirmed to operate under the following conditions.

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### 2.1 Hardware Requirements

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- Flash memory
- Serial communications interface: optional
- Ethernet: optional
- System timer module

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### 2.2 Software Requirements

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The driver is dependent upon the following FIT module:

- Board support package (r\_bsp)
- Byte queue buffer module (r\_byteq)
- Compare match timer (r\_cmt\_rx)
- Flash module (r\_flash\_rx)
- Serial communications interface (SCI: asynchronous/clock synchronous) (r\_sci\_rx): optional
- Ethernet module (r\_ether\_rx): optional
- System timer module (r\_sys\_time\_rx)

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### 2.3 Supported Toolchain

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The driver has been confirmed to work with the toolchain listed in 5.1, Confirmed Operation Environment.

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### 2.4 Header Files

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All API calls and their supporting interface definitions are located in r\_fwup\_if.h.

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### 2.5 Integer Types

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The project uses ANSI C99. These types are defined in stdint.h.

## 2.6 Compile Settings

The configuration option settings of the FIT module are contained in `r_fwup_config.h`.

The names of the options and their setting values are listed in the table below.

Configuration options in <code>r_fwup_config.h</code>	
FWUP_CFG_IMPLEMENTATION_ENVIRONMENT Note: The default is 0.	Specifies the user program environment where the FIT module will be implemented. The API functions that can be used differ depending on the implementation environment. Enter one of the following setting values. 0: Implement in bootloader environment (default). 1: Implement in user program firmware update environment (OS-less environment). 2: Implement in FreeRTOS (OTA) environment. 3: Implement in OS environment other than FreeRTOS.*2  More setting values can be added for additional implementation environments.
FWUP_CFG_COMMUNICATION_FUNCTION Note: The default is 0.	Specifies the communication channel used to download the firmware used to by the user program for the firmware update. Enter one of the following setting values. 0: Connection via SCI communication (default) 1: Connection via Ethernet communication 2: Connection via USB*1 3: Connection via SDHI*1 4: Connection via QSPI*1  More setting values can be added for additional communication channels.
FWUP_CFG_USE_SERIAL_FLASH_FOR_BUFFER Note: The default is 0.	Specifies whether or not external serial flash is used when downloading firmware. 0: Do not use external serial flash (default). 1: Use external serial flash.
FWUP_CFG_SIGNATURE_VERIFICATION Note: The default is 0.	Specifies the signature verification algorithm. 0: Use ECDSA + SHA256 (default). More setting values can be added for additional verification algorithms.
FWUP_CFG_BOOT_PROTECT_ENABLE Note: The default is 0.	Turns boot protection on or off. 0: Boot protection disabled (default). 1: Boot protection enabled.*2
FWUP_CFG_PRINTF_DISABLE Note: The default is 0.	Suppresses display of character strings by sending printf statements to the terminal software in order to minimize ROM usage. 0: Display character strings in terminal software (default). 1: Do not display character strings in terminal software.
FWUP_CFG_SCI_RECEIVE_WAIT Note: The default is 300.	Specifies the UART receive wait time after transmit ends (RTS set to HIGH). The setting unit is microseconds.
FWUP_CFG_PORT_SYMBOL Note: The default is PORTC on the RSK-RX231.	Specifies the port symbol of the I/O port used for RTS, the UART receive request pin.
FWUP_CFG_BIT_SYMBOL Note: The default is B4 on the RSK-RX231.	Specifies the bit symbol of the I/O port used for RTS, the UART receive request pin.

Notes: 1. This item is unsupported, so entering this setting value has no effect.

2. Once boot protection is enabled it may not be possible to change the setting back to “boot protection disabled,” or to change the accessible area or startup area protection function settings, depending on the environment. Exercise due caution regarding the handling of the boot protection setting.



Some combinations of the configuration option settings FWUP\_CFG\_IMPLEMENTATION\_ENVIRONMENT and FWUP\_CFG\_COMMUNICATION\_FUNCTION are allowed and others are not. The allowed combinations are shown below.

**Table 2.1 Allowable Compile Setting Combinations**

		FWUP_CFG_COMMUNICATION_FUNCTION				
		0: SCI	1: Ethernet	2: USB	3: SDHI	4: QSPI
FWUP_CFG_IMPLEMENTATION_ENVIRONMENT	0: Bootloader environment	0	—	—	—	—
	1: User program firmware update environment (OS-less environment)	1	—	2	—	3
	2: Implement in FreeRTOS (OTA) environment.	4	5	6	7	—
	3: Implement in OS environment other than FreeRTOS.	8	—	9	10	11

Note: In the table above, a numeral represents the setting value of FWUP\_ENV\_COMMUNICATION\_FUNCTION, and a dash (—) represents an invalid combination of settings.

The conditions constituting a valid combination of the implementation environment setting and communication channel setting are retained as macros in r\_fwup\_private.h.

**Table 2.2 Valid Setting Combination Macro**

Macro	Value
FWUP_ENV_COMMUNICATION_FUNCTION	0 to 11
Enter one of the following setting values. 0: Connect a PC (COM port) to the SCI, and perform bootloader processing. 1: Connect a PC (COM port) to the SCI, and program the flash memory using primitive R/W. 2: Connect the PC (COM port) to the USB, and program the flash memory using primitive R/W. 3: Connect external storage (an SD card) to the QSPI, and program the flash memory using primitive R/W. 4: Connect a wireless module (SX-ULPGN, BG96, etc.) to the SCI, and program the flash memory using FreeRTOS (OTA). 5: Connect via Ethernet, and program the flash memory using FreeRTOS (OTA). 6: Connect an LTE modem to the USB, and program the flash memory using FreeRTOS (OTA). 7: Connect a wireless module (Type 1DX, etc.) to the SDHI, and program the flash memory using FreeRTOS (OTA). 8: Connect external storage (an SD card) to the SCI, and program the flash memory using the file system. 9: Connect external storage (a USB flash drive) to the USB, and program the flash memory using the file system. 10: Connect external storage (an SD card) to the SDHI, and program the flash memory using the file system. 11: Connect external storage (serial flash) to the QSPI, and program the flash memory using the file system. More setting values can be added to this macro for additional combined conditions.	

Note: For comparison with the above setting combinations, the following macros are defined in r\_fwup\_private.h.

**Table 2.3 Valid Combination Macro Values**

Macro	Value
FWUP_COMM_SCI_BOOTLOADER	0
FWUP_COMM_SCI_PRIMITIVE	1
FWUP_COMM_USB_PRIMITIVE	2
FWUP_COMM_QSPI_PRIMITIVE	3
FWUP_COMM_SCI_AFRTOS	4
FWUP_COMM_ETHER_AFRTOS	5
FWUP_COMM_USB_AFRTOS	6
FWUP_COMM_SDHI_AFRTOS	7
FWUP_COMM_SCI_FS	8
FWUP_COMM_USB_FS	9
FWUP_COMM_SDHI_FS	10
FWUP_COMM_QSPI_FS	11

When additional combinations of the implementation environment setting and communication channel setting are added, additional macro settings can be added.

ex.)

```

#define FWUP_COMM_SCI_BOOTLOADER 0 // Used for Bootloader with SCI connection from COM port.
#define FWUP_COMM_SCI_PRIMITIVE 1 // SCI connection from COM port using primitive R/W.
#define FWUP_COMM_USB_PRIMITIVE 2 // USB connection from COM port using primitive R/W.
#define FWUP_COMM_QSP_PRIMITIVE 3 // Connect external storage (SD card) to QSPI using primitive R/W.
#define FWUP_COMM_SCI_AFRTOS 4 // Connect wireless module to SCI with Amazon FreeRTOS.
#define FWUP_COMM_ETHER_AFRTOS 5 // Connect Eathernet with Amazon FreeRTOS.
#define FWUP_COMM_USB_AFRTOS 6 // Connect LTE modem to USB with Amazon FreeRTOS.
#define FWUP_COMM_SDHI_AFRTOS 7 // Connect wireless module to SDHI with Amazon FreeRTOS.
#define FWUP_COMM_SCI_FS 8 // External storage (SD card + file system) connected to SCI.
#define FWUP_COMM_USB_FS 9 // External storage (USB flash drive + file system) connected to USB.
#define FWUP_COMM_SDHI_FS 10 // External storage (SD card + file system) connected to SDHI.
#define FWUP_COMM_QSPI_FS 11 // External storage (Serial flash + file system) connected to QSPI.

```

## 2.7 Code Size

The code sizes associated with the FIT module are listed in the table below.

**Table 2.4 Code Sizes**

ROM, RAM and Stack Code Sizes			
Device	Category	Memory Used	Remarks
RX65N	ROM	3,294 bytes	boot_loader Project
		3,983 bytes	fwup_main Project
		3,050 bytes	eol_main Project
		5,396 bytes	aws_demos Project
	RAM	36,968 bytes	boot_loader Project
		3,217 bytes	fwup_main Project
		2,193 bytes	eol_main Project
		1,256 bytes	aws_demos Project
	Max. stack size used	1,168 bytes	boot_loader Project
		2,192 bytes	fwup_main Project
		800 bytes	eol_main Project
		1,792 bytes	aws_demos Project
	RX231	ROM	3,665 bytes
3,949 bytes			fwup_main Project
2,961 bytes			eol_main Project
RAM		2,961 bytes	boot_loader Project
		3,217 bytes	fwup_main Project
		2,193 bytes	eol_main Project
Max. stack size used		1,384 bytes	boot_loader Project
		2,172 bytes	fwup_main Project
		772 bytes	eol_main Project

### Note

- Optimization level : Level 2
- Link module optimization : On
- Optimization method : Code size optimization
- Remove unreferenced variables / functions : Off
- FWUP\_CFG\_PRINTF\_DISABLE(Config) : 1

## 2.8 Arguments

For the structures used as API function arguments, refer to Table 2.4.

**Table 2.5 OTA file context**

```
typedef struct
{
    uint16_t usSize; /* Size, in bytes, of the signature. */
    uint8_t ucData[ kOTA_MaxSignatureSize ]; /* The binary signature data. */
} Sig256_t;

typedef struct OTA_FileContext
{
    uint8_t * pucFilePath; /*!< Local file pathname. */
    union
    {
        int32_t IFileHandle; /*!< Device internal file pointer or handle.
                             * File type is handle after file is open for write. */
        #if WIN32
        FILE * pxFile; /*!< File type is stdio FILE structure after file is open for write. */
        #endif
        uint8_t * pucFile; /*!< File type is RAM/Flash image pointer after file is open for write. */
    };
    uint32_t ulFileSize; /*!< The size of the file in bytes. */
    uint32_t ulBlocksRemaining; /*!< How many blocks remain to be received (a code optimization). */
    uint32_t ulFileAttributes; /*!< Flags specific to the file being received (e.g. secure, bundle, archive). */
    uint32_t ulServerFileID; /*!< The file is referenced by this numeric ID in the OTA job. */
    uint8_t * pucJobName; /*!< The job name associated with this file from the job service. */
    uint8_t * pucStreamName; /*!< The stream associated with this file from the OTA service. */
    Sig256_t * pxSignature; /*!< Pointer to the file's signature structure. */
    uint8_t * pucRxBlockBitmap; /*!< Bitmap of blocks received (for de-duping and missing block request). */
    uint8_t * pucCertFilePath; /*!< Pathname of the certificate file used to validate the receive file. */
    uint8_t * pucUpdateUriPath; /*!< Url for the file. */
    uint8_t * pucAuthScheme; /*!< Authorization scheme. */
    uint32_t ulUpdaterVersion; /*!< Used by OTA self-test detection, the version of FW that did the update. */
    bool_t xIsInSelfTest; /*!< True if the job is in self test mode. */
    uint8_t * pucProtocols; /*!< Authorization scheme. */
} OTA_FileContext_t;
```

---

## 2.9 Return Values

---

This section describes return values of API functions. This enumeration is located in `r_fwup_if.h` as are the prototype declarations of API functions.

**Table 2.6 API Return Value Settings**

```
typedef enum e_fwup_err
{
    FWUP_SUCCESS = 0,           // Normally terminated.
    FWUP_FAIL,                 // Illegal terminated.
    FWUP_IN_PROGRESS,         // Firmware update is in progress.
    FWUP_END_OF_LIFE,         // End Of Life process finised.
    FWUP_ERR_ALREADY_OPEN,    // Firmware Update module is in use by another process.
    FWUP_ERR_NOT_OPEN,        // R_FWUP_Open function is not executed yet.
    FWUP_ERR_IMAGE_STATE,     // Platform image status not suitable for firmware update.
    FWUP_ERR_LESS_MEMORY,     // Out of memory.
    FWUP_ERR_FLASH,           // Detect error of r_flash module.
    FWUP_ERR_COMM,            // Detect error of communication module.
    FWUP_ERR_STATE_MONITORING, // Detect error of state monitoring module.
} fwup_err_t;
```

---

## 2.10 Adding the FIT Module to Your Project

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The module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e<sup>2</sup> studio  
By using the Smart Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “RX Smart Configurator User’s Guide: e<sup>2</sup> studio (R20AN0451)” for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e<sup>2</sup> studio  
By using the FIT Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)” for details.

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## 2.11 Note on Status Transition Monitoring Using System Timer

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The module uses the system timer to perform status transition monitoring, and the specification stipulates that an error end occurs when more than the specified duration elapses without a status transition. The default value is one minute. Take appropriate measures to ensure that the status does not remain fixed for longer than the specified duration.

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## 2.12 “for”, “while” and “do while” Statements

---

In the module, “for”, “while” and “do while” statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with “WAIT\_LOOP” as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with “WAIT\_LOOP”.

Target devices describing “WAIT\_LOOP”

while statement example:

```
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}
```

for statement example:

```
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}
```

do while statement example:

```
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */
```

### 3. API Functions

#### 3.1 R\_FWUP\_Open Function

**Table 3.1 R\_FWUP\_Open Function Specifications**

Format	fwup_err_t R_FWUP_Open (void)
Description	Performs processing to open the firmware update module. Performs processing to open the resources used by the firmware update module, makes OS initial settings (when using an OS), and initializes variables.
Parameters	None
Return Values	FWUP_SUCCESS : Normal end
	FWUP_ERR_ALREADY_OPEN : Already open
	FWUP_ERR_LESS_MEMORY : Insufficient memory
	FWUP_ERR_IMAGE_STATE : Updating not possible in current flash status
	FWUP_ERR_FLASH : Flash module error
	FWUP_ERR_COMM : Communication module error
	FWUP_ERR_STATE_MONITORING : Status transition monitoring module error
Special Notes	—

#### 3.2 R\_FWUP\_Close Function

**Table 3.2 R\_FWUP\_Close Function Specifications**

Format	fwup_err_t R_FWUP_Close (void)
Description	Performs processing to close the firmware update module. Performs processing to close the resources used by the firmware update module, and makes OS end settings (when using an OS).
Parameters	None
Return Values	FWUP_SUCCESS : Normal end
	FWUP_ERR_NOT_OPEN : Not open
	FWUP_ERR_FLASH : Flash module error
	FWUP_ERR_COMM : Communication module error
	FWUP_ERR_STATE_MONITORING : Status transition monitoring module error
Special Notes	—

### 3.3 R\_FWUP\_Operation Function

**Table 3.3 R\_FWUP\_Operation Function Specifications**

Format	fwup_err_t R_FWUP_Operation (void)
Description	<p>Performs firmware update processing from the user program. Obtains the firmware data to be applied as an update from the communication channel specified in the configuration settings, programs the flash memory, and performs signature verification.</p> <ul style="list-style-type: none"> <li>• If the status of the flash memory to be updated is other than VALID or INITIAL_FIRM_INSTALLING, the firmware cannot be updated, so a value of FWUP_ERR_IMAGE_STATE is returned.</li> <li>• If the return value is FWUP_IN_PROGRESS, a firmware update is currently in progress, so call this function again later.</li> <li>• If the return value is FWUP_SUCCESS, the firmware update is complete. Call the R_FWUP_SoftwareReset function. Processing transitions to the new firmware after a software reset is applied.</li> <li>• If the return value is FWUP_FAIL, the firmware update failed. Cancel the error and call this function again.</li> </ul>
Parameters	None
Return Values	FWUP_SUCCESS : Firmware update normal end
	FWUP_FAIL : Firmware update error occurred
	FWUP_IN_PROGRESS : Firmware update in progress
	FWUP_ERR_NOT_OPEN : Not open
	FWUP_ERR_IMAGE_STATE : Updating not possible in current flash status
	FWUP_ERR_STATE_MONITORING : Firmware update status has not changed for more than specified duration
Special Notes	—

### 3.4 R\_FWUP\_SoftwareReset Function

**Table 3.4 R\_FWUP\_SoftwareReset Function Specifications**

Format	void R_FWUP_SoftwareReset ( void )
Description	Applies a software reset.
Parameters	None
Return Values	None
Special Notes	—



### 3.5 R\_FWUP\_SetEndOfLife Function

**Table 3.5 R\_FWUP\_SetEndOfLife Function Specifications**

Format	fwup_err_t R_FWUP_SetEndOfLife ( void )
Description	<p>Performs end of life processing for the user program.</p> <p>[Note] When the status is normal end (FWUP_SUCCESS) after this function is called, end of life (EOL) processing is not yet complete. To finish end of life (EOL) processing after this function runs, it is necessary to call the R_FWUP_SoftwareReset function to apply a software reset accompanied by a bank swap, and to execute the remaining end of life processing using the bootloader.</p>
Parameters	None
Return Values	<p>FWUP_SUCCESS : Normal end</p> <p>FWUP_ERR_NOT_OPEN : Not open</p> <p>FWUP_ERR_IMAGE_STATE : Updating not possible in current flash status</p> <p>FWUP_ERR_FLASH : Flash module error</p> <p>FWUP_ERR_COMM : Communication module error</p>
Special Notes	—

### 3.6 R\_FWUP\_SecureBoot Function

**Table 3.6 R\_FWUP\_SecureBoot Function Specifications**

Format	int32_t R_FWUP_SecureBoot ( void )
Description	<p>Performs secure boot processing using the bootloader.</p> <ul style="list-style-type: none"> <li>Performs signature verification to check for tampering before allowing the newly installed firmware to run.</li> <li>If no firmware is installed, the function obtains the firmware data to be applied as an update from the communication channel specified in the configuration settings, programs the flash memory, and performs signature verification.</li> <li>If the firmware to be applied as an update is specified by the user program, it is substituted as the startup firmware.</li> <li>If end of life (EOL) processing is specified by the user program, this function erases the firmware.</li> <li>If the return value is FWUP_IN_PROGRESS, a secure boot is currently in progress, so call this function again later.</li> <li>If the return value is FWUP_SUCCESS, the secure boot is complete. Call the R_FWUP_ExecuteFirmware function to transition processing to the newly installed or updated firmware.</li> <li>If the return value is FWUP_FAIL, the secure boot failed. If necessary, cancel the error and call this function again.</li> </ul>
Parameters	None
Return Values	<p>FWUP_SUCCESS : Secure boot normal end</p> <p>FWUP_FAIL : Secure boot error occurred</p> <p>FWUP_IN_PROGRESS : Secure boot in progress</p>
Special Notes	—

### 3.7 R\_FWUP\_ExecuteFirmware Function

**Table 3.7 R\_FWUP\_ExecuteFirmware Function Specifications**

Format	void R_FWUP_ExecuteFirmware ( void )
Description	Transfers processing to the installed or updated firmware. [Note] The start address of the firmware to which processing is transferred may differ depending on the MCU family or series. It may be necessary to implement processing to obtain the firmware start address to match the implementation environment. [Example: RX65N] Transfer processing to the address set in macro USER_RESET_VECTOR_ADDRESS.
Parameters	None
Return Values	None
Special Notes	—

### 3.8 R\_FWUP\_Abort Function

**Table 3.8 R\_FWUP\_Abort Function Specifications**

Format	OTA_Err_t R_FWUP_Abort ( OTA_FileContext_t * const C )
Description	Stops OTA update processing.
Parameters	* C : File context
Return Values	kOTA_Err_None : Normal end kOTA_Err_FileClose : File context close error
Special Notes	—

### 3.9 R\_FWUP\_CreateFileForRx Function

**Table 3.9 R\_FWUP\_CreateFileForRx Function Specifications**

Format	OTA_Err_t R_FWUP_CreateFileForRx ( OTA_FileContext_t * const C )
Description	Applies initial settings for OTA. Creates a file to store the received data.
Parameters	* C : File context
Return Values	kOTA_Err_None : Normal end kOTA_Err_RxFileCreateFailed : File creation error
Special Notes	—

### 3.10 R\_FWUP\_CloseFile Function

**Table 3.10 R\_FWUP\_CloseFile Function Specifications**

Format	OTA_Err_t R_FWUP_CloseFile ( OTA_FileContext_t * const C )
Description	Closes the specified file. Performs signature verification on the firmware image downloaded to a buffer area in a temporary area. Writes header information for the buffer area in the temporary area.
Parameters	* C : File context
Return Values	kOTA_Err_None : Normal end
	kOTA_Err_FileClose : File close error
	kOTA_Err_SignatureCheckFailed : Signature verification error
Special Notes	—

### 3.11 R\_FWUP\_WriteBlock Function

**Table 3.11 R\_FWUP\_WriteBlock Function Specifications**

Format	int16_t R_FWUP_WriteBlock ( OTA_FileContext_t * const C, uint32_t ulOffset, uint8_t * const pacData, uint32_t ulBlockSize )
Description	Writes a data block to the specified file at the specified offset. When the operation is successful, returns the number of bytes written.
Parameters	* C : File context
	ulOffset : Code flash write destination offset
	* pacData : Write data
	ulBlockSize : Write data size
Return Values	R_OTA_ERR_QUEUE_SEND_FAIL (-2) : Error writing to code flash
	Other than above: : Number of bytes written to code flash
Special Notes	—

### 3.12 R\_FWUP\_ActiveNewImage Function

**Table 3.12 R\_FWUP\_ActiveNewImage Function Specifications**

Format	OTA_Err_t R_FWUP_ActiveNewImage ( void )
Description	Activates or launches the new firmware image. Calls the R_FWUP_ResetDevice() function to apply a software reset.
Parameters	None
Return Values	kOTA_Err_None : Normal end
Special Notes	—

### 3.13 R\_FWUP\_ResetDevice Function

**Table 3.13 R\_FWUP\_ResetDevice Function Specifications**

Format	OTA_Err_t R_FWUP_ResetDevice ( void )
Description	Calling this function generates a software reset, after which the new firmware is launched through processing by the bootloader.
Parameters	None
Return Values	kOTA_Err_None : Normal end
Special Notes	—

### 3.14 R\_FWUP\_SetPlatformImageState Function

**Table 3.14 R\_FWUP\_SetPlatformImageState Function Specifications**

Format	OTA_Err_t R_FWUP_SetPlatformImageState ( OTA_ImageState_t eState )
Description	Sets the life cycle status to the status specified by a parameter. When updating to the new firmware finishes, the function erases the buffer area in the temporary area.
Parameters	eState : Specified status
Return Values	kOTA_Err_None : Normal end kOTA_Err_CommitFailed : Commit error
Special Notes	—

### 3.15 R\_FWUP\_GetPlatformImageState Function

**Table 3.15 R\_FWUP\_GetPlatformImageState Function Specifications**

Format	OTA_PAL_ImageState_t R_FWUP_GetPlatformImageState ( void )
Description	Returns the current life cycle status.
Parameters	None
Return Values	Current life cycle status
Special Notes	—

### 3.16 R\_FWUP\_CheckFileSignature Function

**Table 3.16 R\_FWUP\_CheckFileSignature Function Specifications**

Format	OTA_Err_t R_FWUP_CheckFileSignature ( OTA_FileContext_t * const C )
Description	Checks the signature of the specified file.
Parameters	* C : File context
Return Values	kOTA_Err_None : Normal end kOTA_Err_SignatureCheckFailed : Signature verification error
Special Notes	—

### 3.17 R\_FWUP\_ReadAndAssumeCertificate Function

**Table 3.17 R\_FWUP\_ReadAndAssumeCertificate Function Specifications**

Format	uint8_t * R_FWUP_ReadAndAssumeCertificate ( const uint8_t * const pucCertName uint32_t * const ulSignerCertSize )
Description	Reads and returns the specified signer certificate from the file system.
Parameters	* pucCertName : Certificate file name * ulSignerCertSize : Certificate size
Return Values	Pointer to certificate data
Special Notes	—

### 3.18 R\_FWUP\_GetVersion Function

**Table 3.18 R\_FWUP\_GetVersion Function Specifications**

Format	uint32_t R_FWUP_GetVersion ( void )
Description	Returns the version number of the FIT module.
Parameters	None
Return Values	Version number
Special Notes	—

## 4. Demo Project

The demo project includes a main() function that utilizes the FIT module and its dependent modules. The FIT module includes the following demo project.

### 4.1 Firmware Update Using Serial Communications Interface (SCI) of RX65N

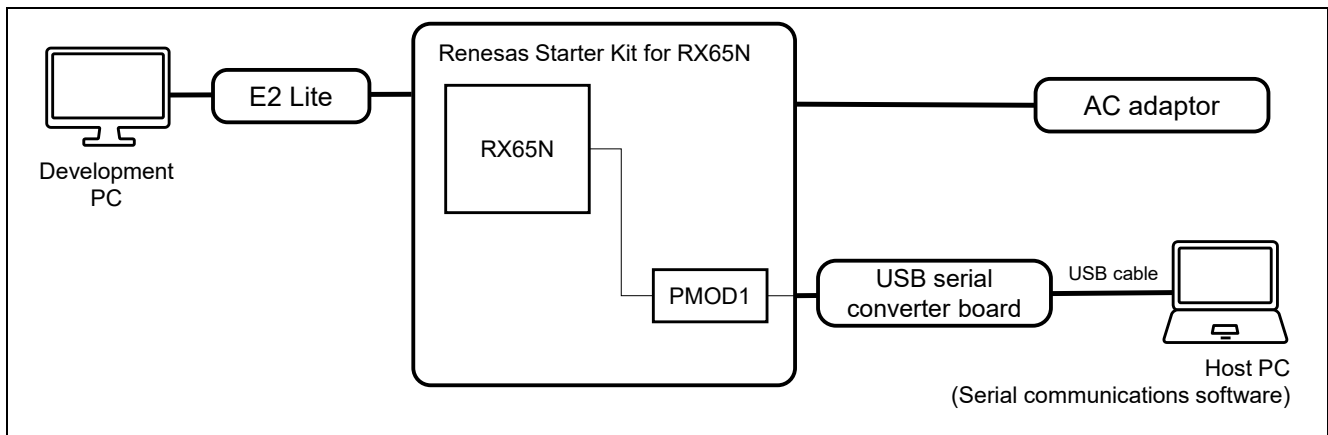
The firmware update demo utilizes the serial communications interface (SCI) of the RX65N, which is mounted on the RSK RX65N starter kit board. Communication with the terminal software takes place via SCI channels configured as a UART.

The firmware update demo uses serial port SCI6, which interfaces with the PMOD1. The PMOD1 connector is connected to a serial converter board.

A PC running terminal software is required for data input and output.

**Table 4.1 Device Configuration**

No.	Device	Description
1	Development PC	The PC used for development.
2	Evaluation board (Renesas Starter Kit for RX65N)	—
3	Host PC (running terminal software such as TeraTerm)	PC running serial communication software that supports XMODEM/SUM transfer protocol (The development PC may also be used for this purpose.)
4	USB serial converter board	Converts the serial I/O signals of the Renesas Starter Kit for RX65N to and from USB serial format and connects to the host PC via a USB cable.
5	USB cable	Implements a USB connection between the USB serial converter board and the host PC.



**Figure 4.1 RSK RX65N Device Connection Diagram**

**Table 4.2 Communication Specifications**

Item	Description
Communication system	Asynchronous communication
Bit rate	115,200 bps
Data length	8 bits
Parity	None
Stop bit	1 bit
Flow control	None

### 4.1.1 Generating the Firmware Update

1. To ensure the integrity of the firmware to be applied as an update, the firmware update is digitally signed (ECDSA + SHA256) and the signature is used to verify its integrity. To perform verification, the following code must be added to the `fwup_main_RX65N` sample application.

- Tinycrypt library
- Base64 decode function
- Key file used for digital signature

The procedure for adding these items is as follows.

(1) Adding the Tinycrypt library

After obtaining the files from <https://github.com/renesas/amazon-freertos/tree/master/libraries/3rdparty/tinycrypt>, add the `lib` folder to the `src/src/tinycrypt/lib` folder of the `fwup_main_RX65N` project.

(2) Adding the Base64 decode function

After obtaining the files from [https://github.com/renesas/amazon-freertos/tree/master/projects/renesas/rx65n-rsk/e2studio/boot\\_loader/src/src](https://github.com/renesas/amazon-freertos/tree/master/projects/renesas/rx65n-rsk/e2studio/boot_loader/src/src), add `base64_decode.c` and `base64_decode.h` to the `src/src` folder of the `fwup_main_RX65N` project.

(3) Adding the key file

After obtaining the files from [https://github.com/renesas/amazon-freertos/tree/master/projects/renesas/rx65n-rsk/e2studio/boot\\_loader/src/](https://github.com/renesas/amazon-freertos/tree/master/projects/renesas/rx65n-rsk/e2studio/boot_loader/src/), add the `key` folder to the `src/key` folder of the `fwup_main_RX65N` project. After adding the folder, enter the public key information for signature verification in `code_signer_public_key.h`.

Refer to the following link for instructions on adding the information.

[https://github.com/renesas/amazon-freertos/wiki/OTAの活用#手順まとめ](https://github.com/renesas/amazon-freertos/wiki/OTA%20%E3%81%A7%E3%81%87%E3%81%8C%E3%81%8A%E3%81%8B%E3%81%8D%E3%81%8E%E3%81%8F%E3%81%90%E3%81%91%E3%81%92%E3%81%93%E3%81%94%E3%81%95%E3%81%96%E3%81%97%E3%81%98%E3%81%99%E3%81%9A%E3%81%9B%E3%81%9C%E3%81%9D%E3%81%9E%E3%81%9F%E3%81%A0%E3%81%A1%E3%81%A2%E3%81%A3%E3%81%A4%E3%81%A5%E3%81%A6%E3%81%A7%E3%81%A8%E3%81%A9%E3%81%AA%E3%81%AB%E3%81%AC%E3%81%AD%E3%81%AE%E3%81%AF%E3%81%B0%E3%81%B1%E3%81%B2%E3%81%B3%E3%81%B4%E3%81%B5%E3%81%B6%E3%81%B7%E3%81%B8%E3%81%B9%E3%81%BA%E3%81%BB%E3%81%BC%E3%81%BD%E3%81%BE%E3%81%BF%E3%81%C0%E3%81%C1%E3%81%C2%E3%81%C3%E3%81%C4%E3%81%C5%E3%81%C6%E3%81%C7%E3%81%C8%E3%81%C9%E3%81%CA%E3%81%CB%E3%81%CC%E3%81%CD%E3%81%CE%E3%81%CF%E3%81%D0%E3%81%D1%E3%81%D2%E3%81%D3%E3%81%D4%E3%81%D5%E3%81%D6%E3%81%D7%E3%81%D8%E3%81%D9%E3%81%DA%E3%81%DB%E3%81%DC%E3%81%DD%E3%81%DE%E3%81%DF%E3%81%E0%E3%81%E1%E3%81%E2%E3%81%E3%E3%81%E4%E3%81%E5%E3%81%E6%E3%81%E7%E3%81%E8%E3%81%E9%E3%81%EA%E3%81%EB%E3%81%EC%E3%81%ED%E3%81%EE%E3%81%EF%E3%81%F0%E3%81%F1%E3%81%F2%E3%81%F3%E3%81%F4%E3%81%F5%E3%81%F6%E3%81%F7%E3%81%F8%E3%81%F9%E3%81%FA%E3%81%FB%E3%81%FC%E3%81%FD%E3%81%FE%E3%81%FF)

(4) Create the keys to be used for firmware verification in OpenSSL.

(5) To enable firmware verification using ECDSA + SHA256, import the public key for signature verification (`secp256r1.publickey`) by the bootloader.

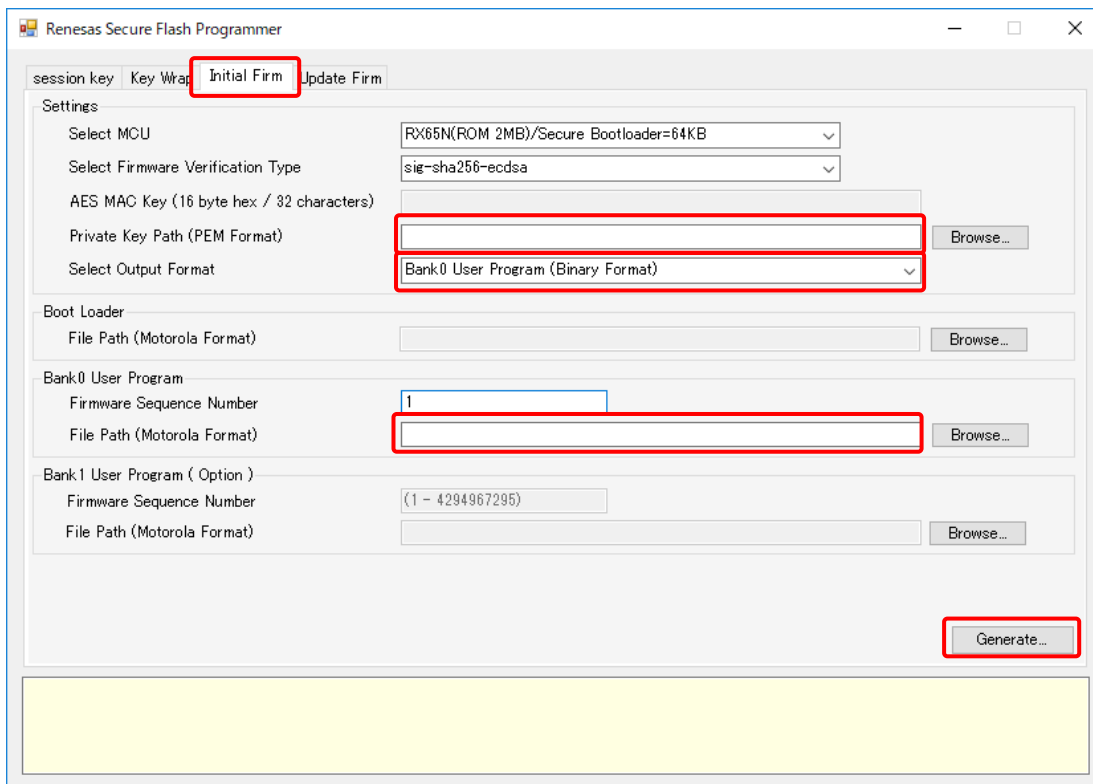
2. Build the **fwup\_main\_RX65N** sample application and convert the resulting .mot file into an .RSU file. This is the “initial firmware.”

The procedure for converting the .mot file into an .RSU file is as follows.

Download Renesas Secure Flash Programmer.exe from

<https://github.com/renesas/mot-file-converter/tree/master/Renesas%20Secure%20Flash%20Programmer/bin/Debug> and then run it. (You will also need the other files archived along with it, so download them too.)

- Select the [Initial Firm] tab and set the parameters as shown in the screenshot below.
- Set the path of secp256r1.private key in **Private Key Path** of **Settings**.
- Set Bank0 User Program (Binary Format) to **Select Output format** in **Settings**.
- For **File Path** under **Bank 0 User Program**, specify the path of the .mot file created as described above.
- Click the [Generate] button to generate an .RSU file, and store it in the **init\_firmware** folder.





3. Open **src/main.c** and remove the slashes from the left of the commented-out lines to make them valid.

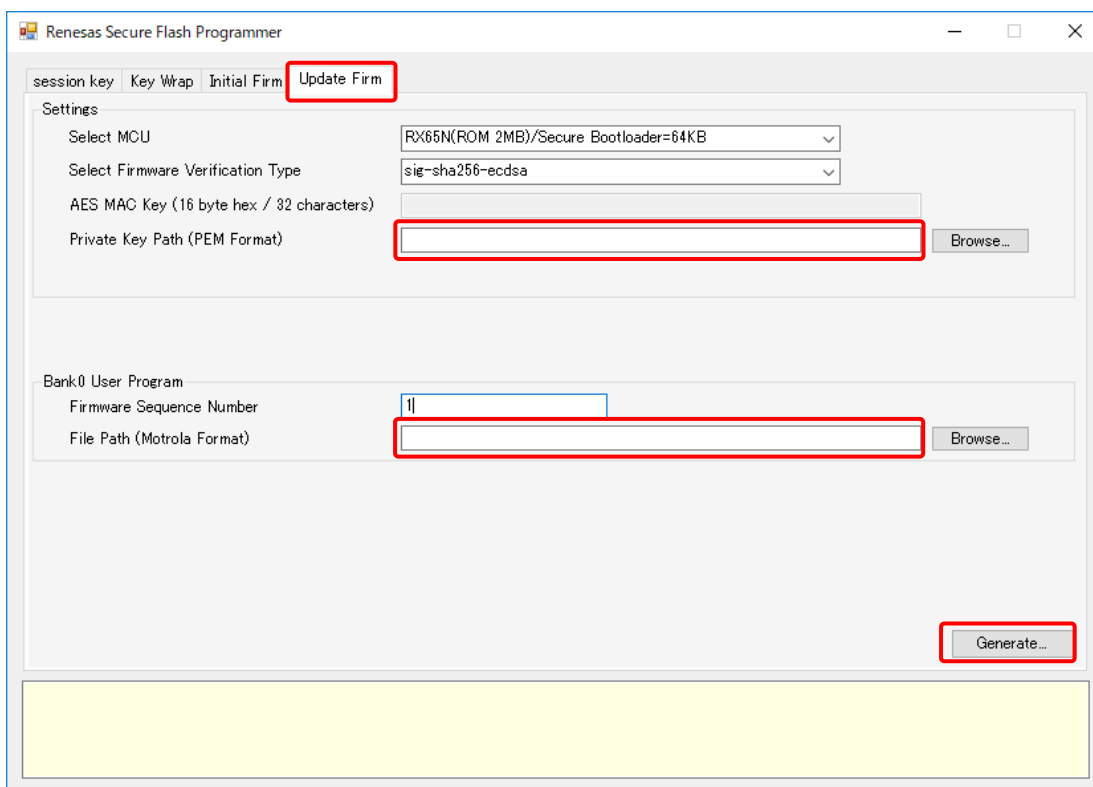
Lines 84 to 88 in main.c

```
// printf("[FWUP_main DEMO] Firmware update demonstration completed.\r\n");
// while(1)
// {
//     /* infinity loop */
// }
```

Build the project once again, and convert the resulting .mot file into an .RSU file. This is the “next firmware.”

The procedure for converting the .mot file into an .RSU file is as follows.

- Select the [Update Firm] tab and set the parameters as shown in the screenshot below.
- Set the path of secp256r1.private key in **Private Key Path** of **Settings**.
- For **File Path** under **Bank 0 User Program**, specify the path of the .mot file created as described above.
- Click the [Generate] button to generate an .RSU file, and store it in the **update\_firmware** folder.



### 4.1.2 Updating the Firmware

1. Connect the PC USB port, USB serial converter board, and PMOD1 on the RSK board as shown in Figure 4.1, RSK RX65N Device Connection Diagram.
2. Launch the terminal software on the PC. Then select the serial COM port assigned to the USB serial converter board.
3. Enter serial communication settings in the terminal software to match the settings of the sample application: 115,200 bps, 8 data bits, no parity, 1 stop bit, no flow control.
4. Build the sample application, download it to the RSK board, and use the debugger to run the application.
5. When you run the software, the following message is output.

```
send "userprog.rsu" via UART.
```

Select the “send file” function in the terminal software, and send the previously created “initial firmware” .RSU file. (Make sure to select the binary transfer option.) The following messages are output while the .RSU file data is being received and written to the code flash.

```
installing firmware...0%(1/960KB).
installing firmware...0%(2/960KB).
installing firmware...0%(3/960KB).
installing firmware...0%(4/960KB).
```

6. When installation and signature verification finish, the application for applying the firmware update is launched, and a message prompting you to input the firmware application is output.

```
jump to user program
[R_FWUP_GetPlatformImageState] is called.
Function call: R_FWUP_GetPlatformImageState: [2]
[R_FWUP_CreateFileForRx] is called.
[R_FWUP_CreateFileForRx] Receive file created.
[R_FWUP_GetPlatformImageState] is called.
Function call: R_FWUP_GetPlatformImageState: [2]
-----
Firmware update user program
-----
Send Update firmware via UART.
```

Select the “send file” function in the terminal software, and send the previously created “next firmware” .RSU file. (Make sure to select the binary transfer option.) The following messages are output while the .RSU file data is being received and written to the code flash.

```
[R_FWUP_WriteBlock] is called.
[R_FWUP_Operation] Flash Write: Address = 0xFFE00000, length = 1024 ... OK
[R_FWUP_WriteBlock] is called.
[R_FWUP_Operation] Flash Write: Address = 0xFFE00400, length = 1024 ... OK
```

7. When installation and signature verification of the firmware application finish, execution jumps to the firmware application following a bank swap and other processing.

```
jump to user program
[R_FWUP_GetPlatformImageState] is called.
```

8. The firmware application outputs the following message indicating that the demo has completed successfully.

```
[FWUP_main DEMO] Firmware update demonstration completed.
```

### 4.1.3 Generating EOL Firmware

1. Build the `eol_main_RX65N` sample application and convert the resulting `.mot` file into an `.RSU` file. This is the “eol firmware.”

Refer to step 2 above for instructions on converting to `.RSU` file format.

### 4.1.4 Firmware EOL

1. Connect the PC USB port, USB serial converter board, and PMOD1 on the RSK board as shown in Figure 4.1, RSK RX65N Device Connection Diagram.
2. Launch the terminal emulation program (terminal software) on the PC. Then select the serial COM port assigned to the USB serial converter board.
3. Enter serial communication settings in the terminal software to match the settings of the sample application: 115,200 bps, 8 data bits, no parity, 1 stop bit, no flow control.
4. Build the sample application, download it to the RSK board, and use the debugger to run the application.
5. When you run the software, the following message is output.

```
send "userprog.rsu" via UART.
```

Select the “send file” function in the terminal software, and send the previously created “eol firmware” `.RSU` file. (Make sure to select the binary transfer option.) The following messages are output while the `.RSU` file data is being received and written to the code flash.

```
installing firmware...0%(1/960KB).
installing firmware...0%(2/960KB).
installing firmware...0%(3/960KB).
installing firmware...0%(4/960KB).
```

6. When installation and signature verification finish, the end of life (EOL) application is launched.

```
-----
End Of Life (EOL) process of user program
-----
[R_FWUP_SetEndOfLife] erase install area (code flash):OK
[R_FWUP_SetEndOfLife] update bank1 LIFECYCLE_STATE to [LIFECYCLE_STATE_EOL]
[EOL_main] EOL process completely. Bank swap and software reset.
[R_FWUP_ActivateNewImage] Changing the Startup Bank
[R_FWUP_ResetDevice] Resetting the device.
[R_FWUP_ResetDevice] Swap bank...
```

7. When the end of life (EOL) application finishes, processing returns to the bootloader, and EOL processing is executed within the bootloader.

```
-----
RX65N secure boot program
-----
Checking flash ROM status.
bank 0 status = 0xe0 [LIFECYCLE_STATE_EOL]
bank 1 status = 0xf8 [LIFECYCLE_STATE_VALID]
```

8. When the following message is output, EOL processing has completed successfully.

```
End Of Life process finished.
```

## 5. Appendices

### 5.1 Confirmed Operation Environment

This section describes confirmed operation environment for the FIT module.

**Table 5.1 Confirmed Operation Environment (Ver. 1.00)**

Item	Contents
Integrated development environment	Renesas Electronics e <sup>2</sup> studio 2020 07
C compiler	Renesas Electronics C/C++ Compiler for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian order	Little endian
Revision of the module	Rev.1.00
Board used	Renesas Starter Kit+ for RX65N (product No.: RTK500565NSxxxxBE) Renesas Starter Kit+ for RX231 (product No.: R0K505231SxxxBE)
USB serial converter board	Pmod USBUART (Digilent, Inc.) <a href="https://reference.digilentinc.com/reference/pmod/pmodusbuart/start">https://reference.digilentinc.com/reference/pmod/pmodusbuart/start</a>

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.00	Apr.16.21	29	First edition issued

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.5.0-1 October 2020)

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